

PRM5R2N03N3

PFC Device Corporation

30V Single N-Channel MOSFET

Major ratings and characteristics

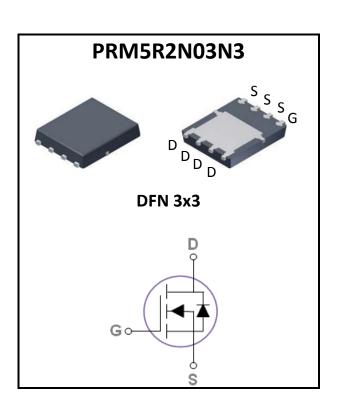
Characteristics	Values	Unit s
V _{DS}	30	V
I _D ⁴ (T _C =25°C)	32	Α
Max. R _{DS(ON)} @V _{GS} =10V	5.2	mΩ
Max. R _{DS(ON)} @V _{GS} =4.5V	9.0	mΩ
T _J Operating Junction Temperature	-50 to +150	°C

General Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

Typical Applications

- Charger Adapter
- Power Tools
- LED Lighting



Features

- Max. $R_{DS(ON)}$ =5.2m Ω @V_{GS}=10V
- Improved dv/dt capability
- Fast switching
- 100% E_{AS} Guaranteed
- Green Device Available

Version 4.0

1. Characteristics

Maximum Ratings Characteristics

($T_A = 25$ °C unless otherwise specified)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate-Source Voltage	±20	V
I_{D}^{4}	Drain Current – Continuous (T _C =25°C)	32	А
ID	Drain Current – Continuous (T _c =100°C)	26	А
I _{DM}	Drain Current – Pulsed ¹	100	А
E _{AS}	Single Pulse Avalanche Energy ²	18	mJ
I _{AS}	Single Pulse Avalanche Current ²	18.9	А
Р	Power Dissipation (T _C =25°C)	25	W
P _D	Power Dissipation – Derate above 25°C	0.20	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient		60	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance Junction to Case		5	°C/W



Electrical Characteristics

($T_J = 25$ °C unless otherwise specified)

Off Characteristics

				_		
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	30			V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =30V, V _{GS} =0V, T _J =25°C			1	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			100	nA

On Characteristics

R _{DS(ON)} Static Drain-Source On-Resistance	Static Drain Source On Registered	V _{GS} =10V, I _D =20A		4.5	5.2	mΩ
	V _{GS} =4.5V, I _D =15A		7.2	9	mΩ	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.0	1.7	2.5	V
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =10A		37		S

Dynamic and switching Characteristics

Qg	Total Gate Charge	V _{DS} =15V, V _{GS} =10V, I _D =20A	 20	
Q_{gs}	Gate-Source Charge		 4.5	 nC
Q _{gd}	Gate-Drain Charge		 3.8	
T _{d(on)}	Turn-On Delay Time		 12	
T _r	Turn-On Rise Time	V_{DD} =15V, V_{GS} =10V, R_{G} =3 Ω	 22	 ns
T _{d(off)}	Turn-Off Delay Time	I _D =20A	 32	 115
T _f	Turn-Off Fall Time		 8	
C _{iss}	Input Capacitance		 1074	
C _{oss}	Output Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz	 485	 pF
C _{rss}	Reverse Transfer Capacitance		 50	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	 2.8	 Ω

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	V _{GS} =0V, I _S =1A	 	1	V
t _{rr}	Reverse Recovery Time	1 20 A di/dt 100 A /up	 18		ns
Q _{rr}	Reverse Recovery Charge	I _S =20A, di/dt=100A/us	 6		nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.

2. V_DD=25V, V_GS=10V, L=0.1mH, RG=25\Omega, Starting TJ=25 $^\circ\!\mathbb{C}$

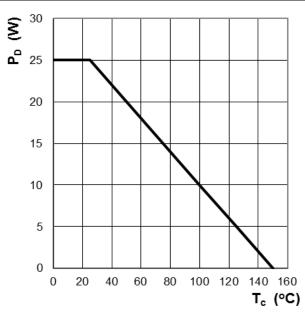
3. The data tested by pulsed, pulse width \leq 300us, duty cycle \leq 2%.

4. Silicon limited.





Ratings and Characteristics Curves





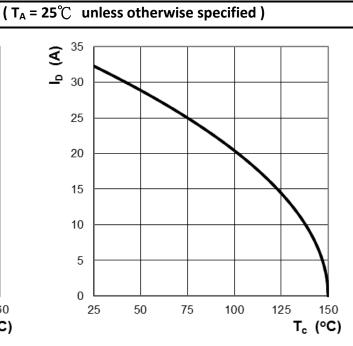
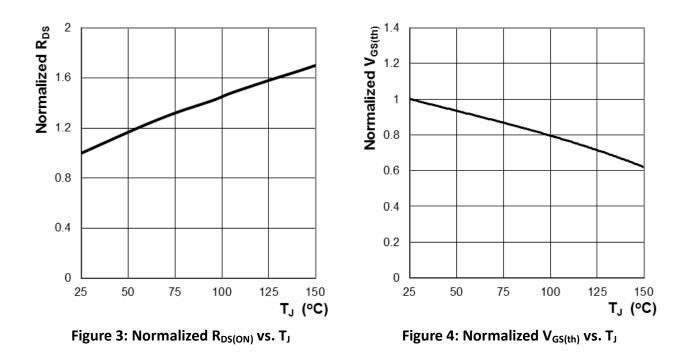


Figure 2: Continuous Drain Current vs. T_c





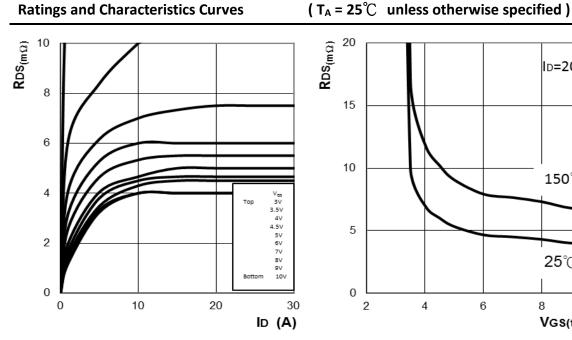


Figure 5: RDS(ON) vs. Drain Current and **Gate Voltage**

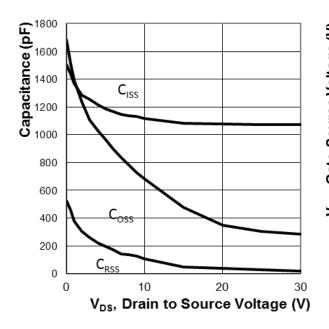


Figure 7: Typ. Capacitance Characteristics

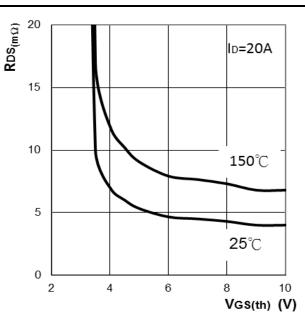


Figure 6: RDS(ON) vs. Gate Voltage

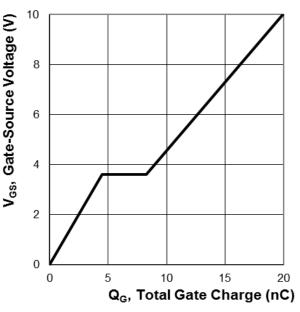


Figure 8: Typ. Gate Charge Characteristics



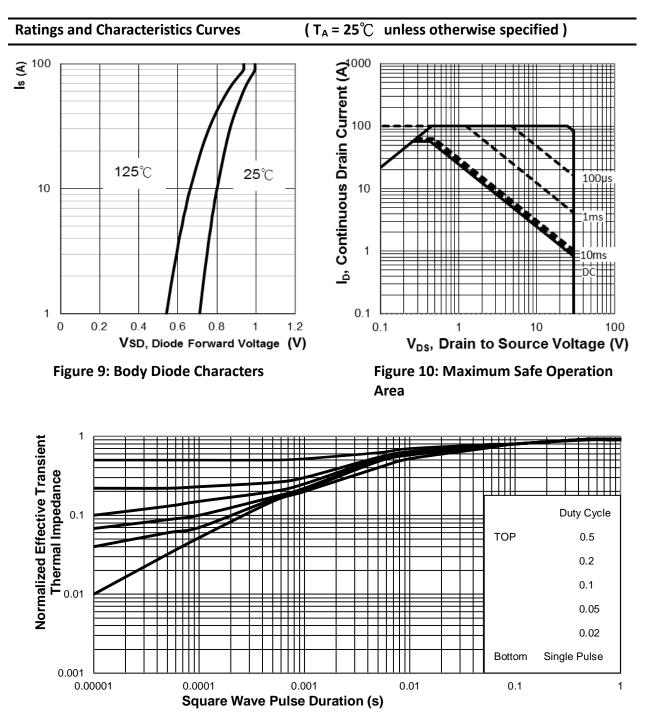
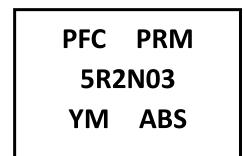


Figure 11: Normalized Thermal Transient Impedance, Junction-to-Case



3. Marking information

Top Marking Rule

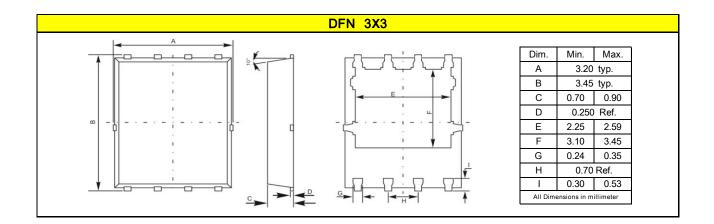


PRM5R2N03 = Product Type Marking Code YM = Date Code Y = Year code M = Month code

ABS = Assembly code

4. Package information

Package Outline Dimensions millimeters





5. Ordering information

Part Number	Package	Delivery mode
PRM5R2N03N3	DFN 3X3	5000 pcs / 13" diameter reel

Mechanical

- Molder Plastic: UL Flammability Classification Rating 94V-0
- Device Weight : 0.0025 ounces (0.072grams) DFN 3X3

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